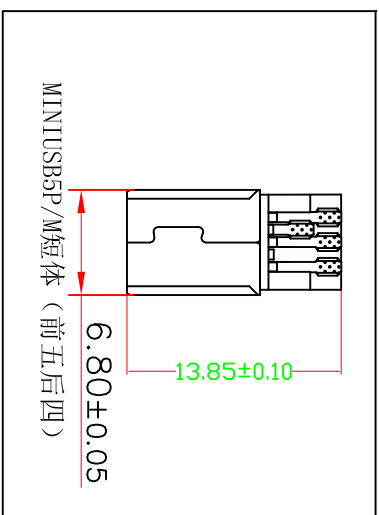
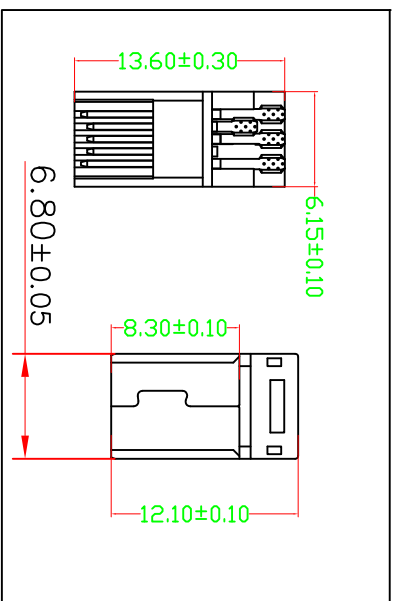
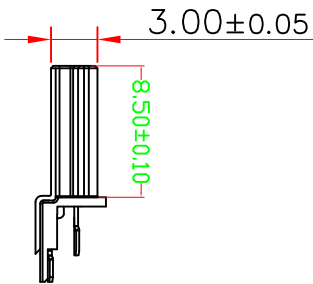
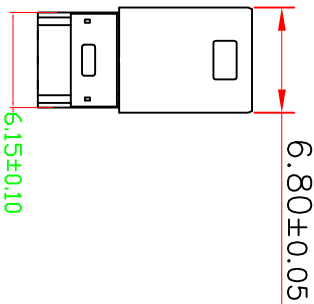
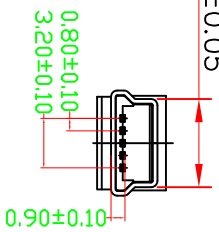
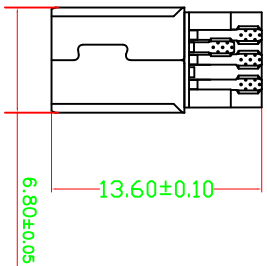


MAPX	MODIFICATION	DATE
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mini-USB-SPIN SOLDER TAIL  
 规格书  
 特性: Specifications  
 电学: Electrical:  
 接触电阻: Contact Resistance  
 30milliohms MAX  
 电介质: Dielectric Withstanding Voltage  
 50V AC AT sea Level  
 绝缘电阻: Insulation Resistance:  
 100MEGA ohms MIN  
 材料: Material:  
 外壳: Housing/Hing Temperature Thermoplastics,  
 UL 94V-0 阻燃等级  
 触点: Contact: Copper Alloy 铜合金  
 壳体: Shell: SPC-SD 塑料  
 表面处理: Finish:  
 触点: Contact: Plated Gold in Mating Area;  
 Tin/Lead Sn Solder Tails  
 接触电阻: 接触电阻  
 壳体: Shell:  
 Tin/Lead Plating 镀锡

产品图  
PRODUCT CHART DWG

深圳市精拓金电子有限公司

公差一览表 TOLERANCE UNLESS OTHERWISE		单位 UNITS	mm	制图 DRAWING	Gavin	制图料号 PRODUCT PART NO.	
X	±0.15	X	±5°	审核 CHKD	郭治富	产品名称 PRODUCT NO.	MINI USB5P公(普通型前五后四)短体
X	±0.10	X	±2°	核准 APPD	黄国荣	角法 VIEW	
XX	±0.05	XX	±1°	日期 DATE	2014/03/16	版本 VER	AD
XXX	±0.03	XXX	±0.5°				

1 2 3 4 7 8 9 10  
 G F E D C B A  
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